

REV.	ECN NO.	LOCATIONS	DESCRIPTION	DATE	DESIGN
A1			update some details	10/20'21	Larry

CUSTOMER DRAWING

RoHS Compliant

ORDERING INFORMATION

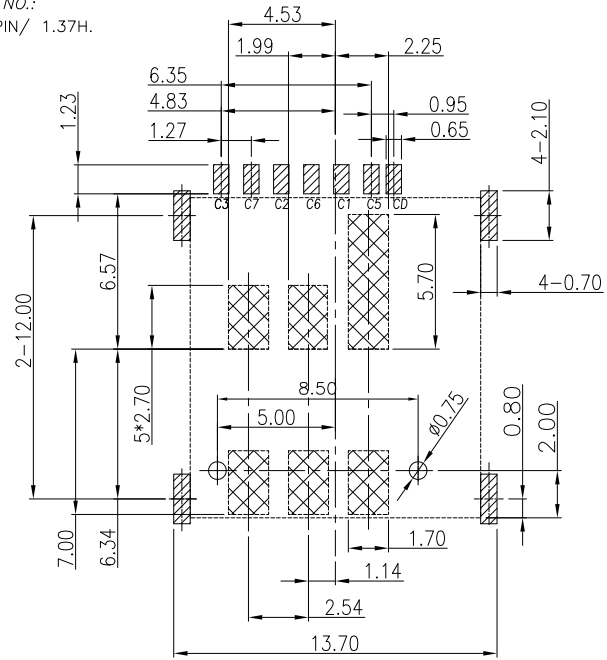
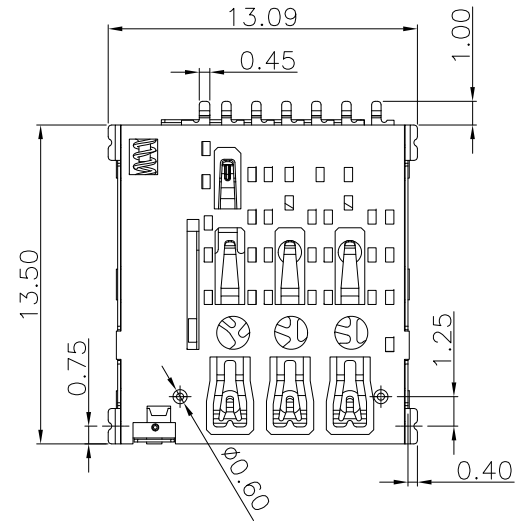
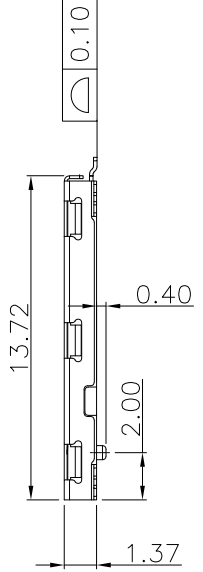
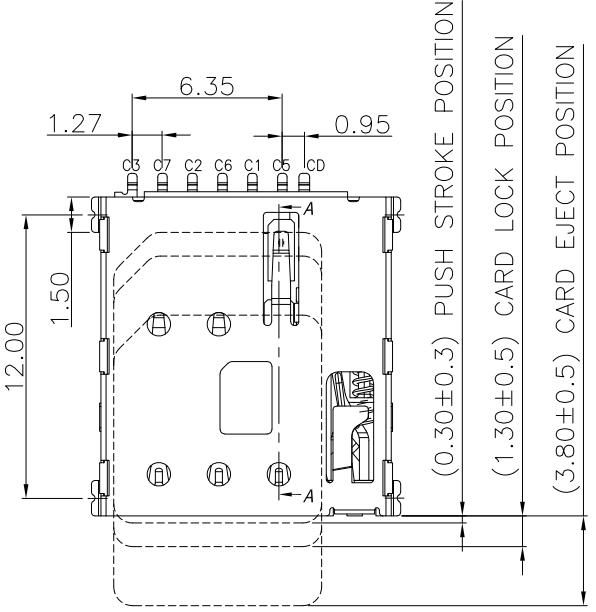
SMPN - S03 (XX T)

① ② ③

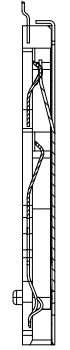
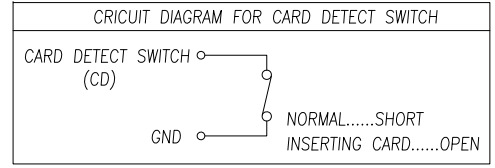
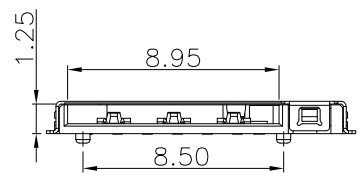
① **PRODUCT SERIES:**
Nano-SIM CARD CONN-
PUSH-PUSH TYPE.

③ **GOLD PLATING**
01: G/F.

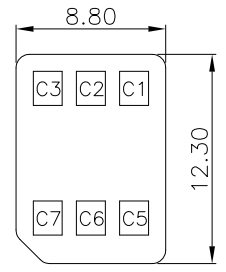
② **ITEM NO.:**
6+1PIN/ 1.37H.



RECOMMENDED PCB LAYOUT
GENERAL TOLERANCE ± 0.05



SECTION A-A



NANO SIM CARD

SIM CARD	
Pin No.	NAME
C1	VCC
C2	RST
C3	CLK
C5	GND
C6	VPP
C7	I/O

DIM	TOL	DIM	TOL
x.x	± 0.30	x.x'	$\pm 3.0'$
x.xx	± 0.20	x.xx'	$\pm 2.0'$
x.xxx	± 0.10	x.xxx'	$\pm 1.0'$

- NOTES:**
- MATERIAL:**
 - HOUSING: LCP, HIGH TEMP, BLACK COLOR.
 - TERMINAL: COPPER ALLOY.
 - SHELL: STAINLESS STEEL.
 - FINISH:**
 - TERMINAL: GOLD ON CONTACT AREA OVER NICKEL PLATED OVERALL.

SUNFUN		SUNFUN TECHNOLOGY LTD			
DRAW NO.	SMPN-S03(A1)	DATE	10/20'21	MATERIAL:	SEE NOTES
DESIGN:	Larry	DATE	10/20'21	FINISH:	SEE NOTES
CHECK:	Larry	DATE	10/20'21	FILE:	SMPN-S03(A1)
REVIEW:	Ziv	DATE	10/20'21	P/N:	SMPN-S03(XXT)
APPROVED	Ziv	DATE	10/20'21	REV.	A1
		SCALE			
		DRAW NAME:		Nano-SIM CARD CONN- PUSH PUSH TYPE/ 6+1PIN 1.37H	
		MODEL:		NANO-SIM CONN	
		UNIT:	mm	SHEET:	1/1